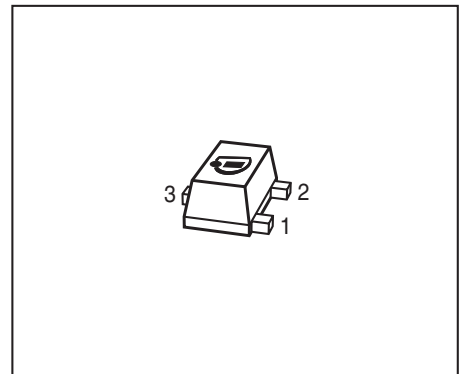


Low Noise Silicon Bipolar RF Transistor

- General purpose Low Noise Amplifier
- Ideal for low current operation
- High breakdown voltage enables operation in automotive applications
- Minimum noise figure 1.0 dB @ 1mA, 1.5 V, 1.9 GHz
- Pb-free (RoHS compliant) and halogen-free thin small flat package (1.2 x 1.2 mm²) with visible leads
- Qualification report according to AEC-Q101 available



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type	Marking	Pin Configuration			Package
BFR340F	FAs	1 = B	2 = E	3 = C	TSFP-3

Maximum Ratings at $T_A = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	6	V
Collector-emitter voltage	V_{CES}	15	
Collector-base voltage	V_{CBO}	15	
Emitter-base voltage	V_{EBO}	2	
Collector current	I_C	20	mA
Base current	I_B	2	
Total power dissipation ¹⁾ $T_S \leq 110\text{ °C}$	P_{tot}	75	mW
Junction temperature	T_J	150	°C
Storage temperature	T_{Stg}	-55 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R_{thJS}	530	K/W

¹⁾ T_S is measured on the collector lead at the soldering point to the pcb

²⁾ For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)

Electrical Characteristics at $T_A = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 1\text{ mA}$, $I_B = 0$	$V_{(BR)CEO}$	6	9	-	V
Collector-emitter cutoff current $V_{CE} = 4\text{ V}$, $V_{BE} = 0$, $T_A = 25^{\circ}\text{C}$ $V_{CE} = 10\text{ V}$, $V_{BE} = 0$, $T_A = 85^{\circ}\text{C}$ Verified by random sampling	I_{CES}	- -	1 2	30 50	nA
Collector-base cutoff current $V_{CB} = 4\text{ V}$, $I_E = 0$	I_{CBO}	-	1	30	
Emitter-base cutoff current $V_{EB} = 1\text{ V}$, $I_C = 0$	I_{EBO}	-	1	500	
DC current gain $I_C = 5\text{ mA}$, $V_{CE} = 3\text{ V}$, pulse measured	h_{FE}	90	120	160	-

Electrical Characteristics at $T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

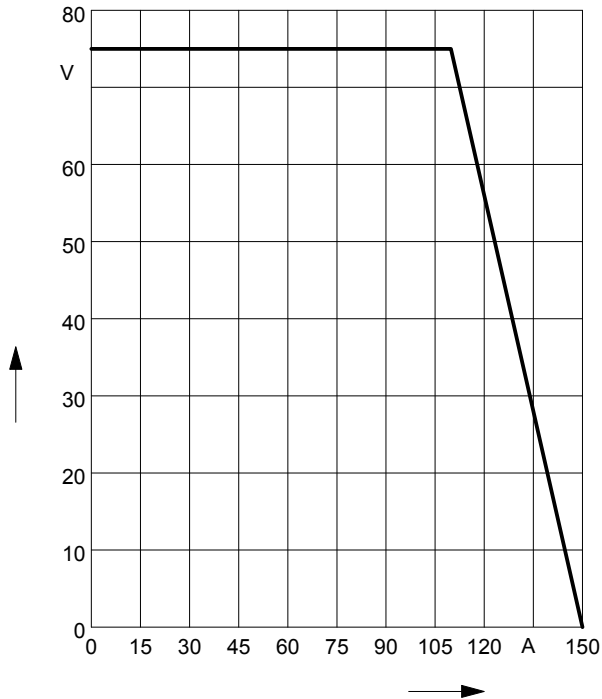
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Transition frequency $I_C = 6\text{ mA}$, $V_{CE} = 3\text{ V}$, $f = 1\text{ GHz}$	f_T	11	14	-	GHz
Collector-base capacitance $V_{CB} = 5\text{ V}$, $f = 1\text{ MHz}$, $V_{BE} = 0$, emitter grounded	C_{cb}	-	0.21	0.4	pF
Collector emitter capacitance $V_{CE} = 5\text{ V}$, $f = 1\text{ MHz}$, $V_{BE} = 0$, base grounded	C_{ce}	-	0.17	-	
Emitter-base capacitance $V_{EB} = 0.5\text{ V}$, $f = 1\text{ MHz}$, $V_{CB} = 0$, collector grounded	C_{eb}	-	0.11	-	
Minimum noise figure $I_C = 3\text{ mA}$, $V_{CE} = 1.5\text{ V}$, $Z_S = Z_{Sopt}$, $f = 100\text{ MHz}$ $I_C = 1\text{ mA}$, $V_{CE} = 1.5\text{ V}$, $Z_S = Z_{Sopt}$, $f = 1.9\text{ GHz}$ $I_C = 1\text{ mA}$, $V_{CE} = 1.5\text{ V}$, $Z_S = Z_{Sopt}$, $f = 2.4\text{ GHz}$	NF_{min}	- - -	0.9 1 1.2	- - -	dB

Electrical Characteristics at $T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

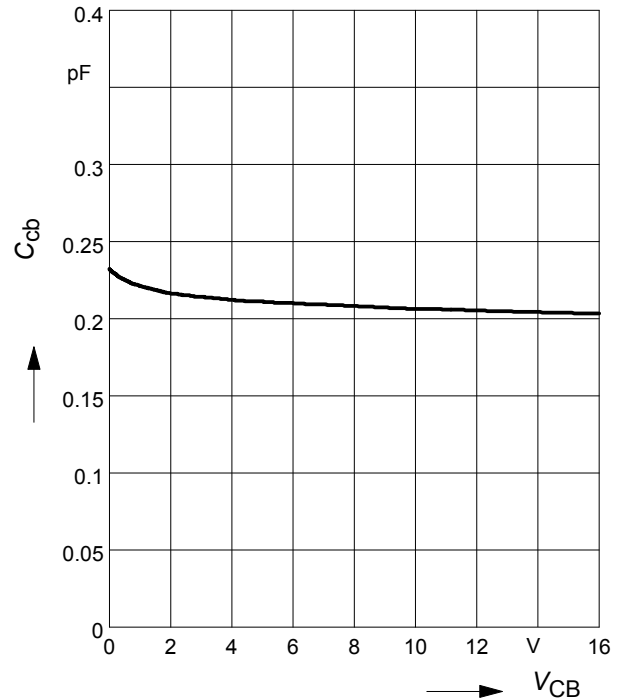
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Maximum power gain ¹⁾ $I_C = 3\text{ mA}$, $V_{CE} = 1.5\text{ V}$, $Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$, $f = 100\text{ MHz}$ $I_C = 5\text{ mA}$, $V_{CE} = 3\text{ V}$, $Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$, $f = 1.8\text{ GHz}$ $f = 3\text{ GHz}$	G_{max}	- - -	28 16.5 13	- - -	dB
Transducer gain $I_C = 3\text{ mA}$, $V_{CE} = 1.5\text{ V}$, $Z_S = Z_L = 50\Omega$, $f = 100\text{ MHz}$ $I_C = 5\text{ mA}$, $V_{CE} = 3\text{ V}$, $Z_S = Z_L = 50\Omega$, $f = 1.8\text{ GHz}$ $f = 3\text{ GHz}$	$ S_{21e} ^2$	- - -	19 14 10	- - -	dB
Third order intercept point at output ²⁾ $V_{CE} = 3\text{ V}$, $I_C = 5\text{ mA}$, $f = 100\text{ MHz}$, $Z_S = Z_L = 50\Omega$ $V_{CE} = 3\text{ V}$, $I_C = 5\text{ mA}$, $f = 1.8\text{ GHz}$, $Z_S = Z_L = 50\Omega$	$IP3$	- -	14 13	- -	dBm
1dB compression point at output $V_{CE} = 3\text{V}$, $I_C = 5\text{ mA}$, $Z_S = Z_L = 50\Omega$, $f = 100\text{ MHz}$ $V_{CE} = 3\text{V}$, $I_C = 5\text{ mA}$, $Z_S = Z_L = 50\Omega$, $f = 1.8\text{ GHz}$	P_{-1dB}	- -	-3 -1	- -	

¹⁾ $G_{ma} = |S_{21e} / S_{12e}| (k - (k^2 - 1)^{1/2})$, $G_{ms} = |S_{21e} / S_{12e}|$
²⁾ IP3 value depends on termination of all intermodulation frequency components.
Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz

Total power dissipation $P_{\text{tot}} = f(T_S)$



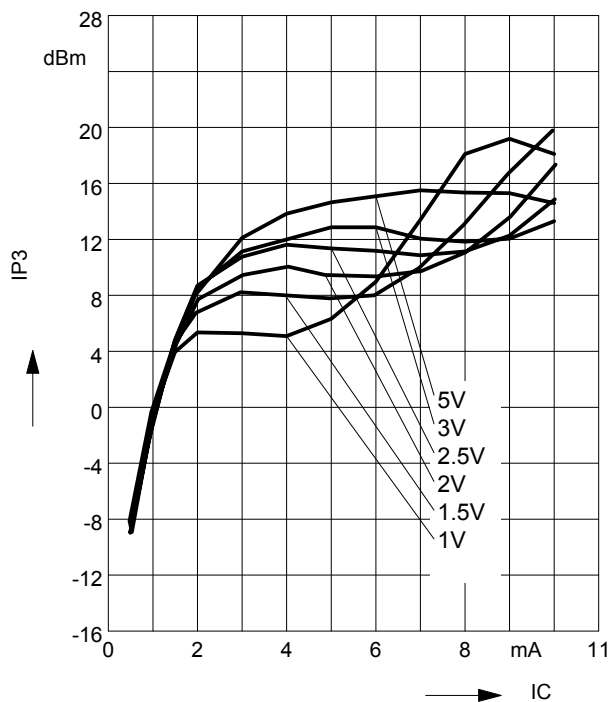
Collector-base capacitance $C_{\text{cb}} = f(V_{\text{CB}})$
 $f = 1\text{MHz}$



Third order Intercept Point $IP_3 = f(I_C)$

(Output, $Z_S = Z_L = 50\Omega$)

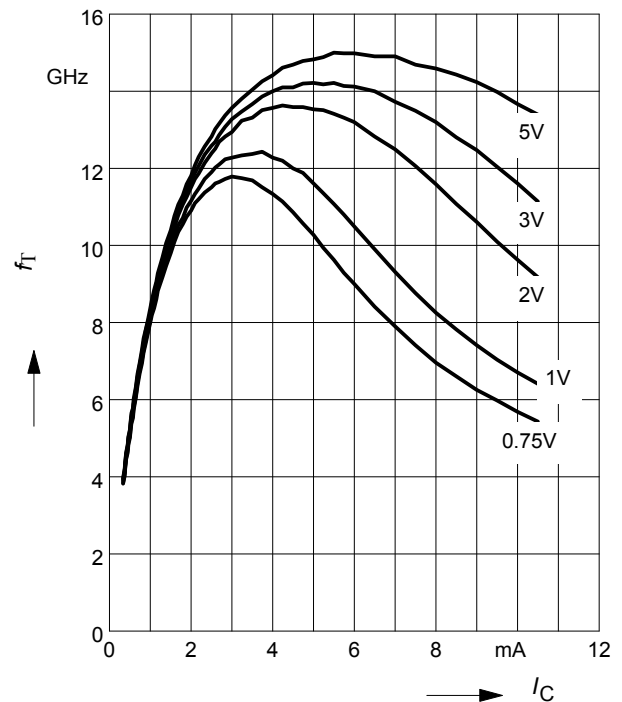
$V_{\text{CE}} = \text{parameter}, f = 1.9\text{GHz}$



Transition frequency $f_T = f(I_C)$

$f = 1\text{GHz}$

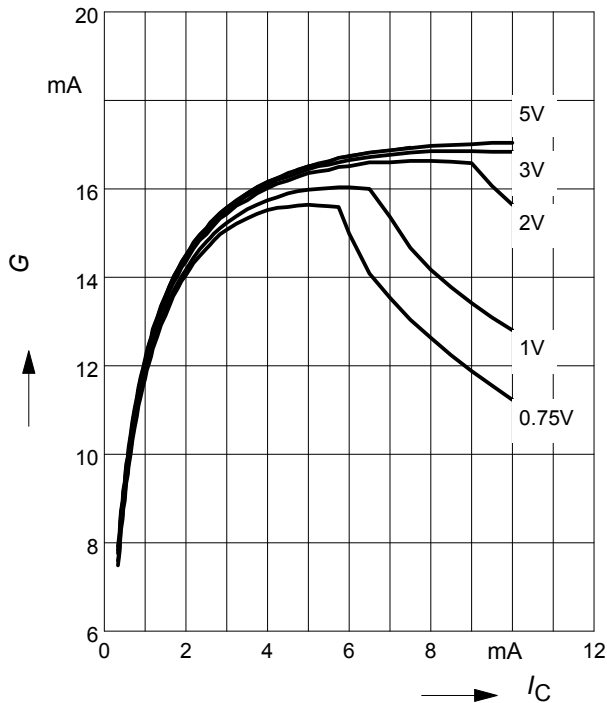
$V_{\text{CE}} = \text{parameter}$



Power gain G_{ma} , $G_{ms} = f(I_C)$

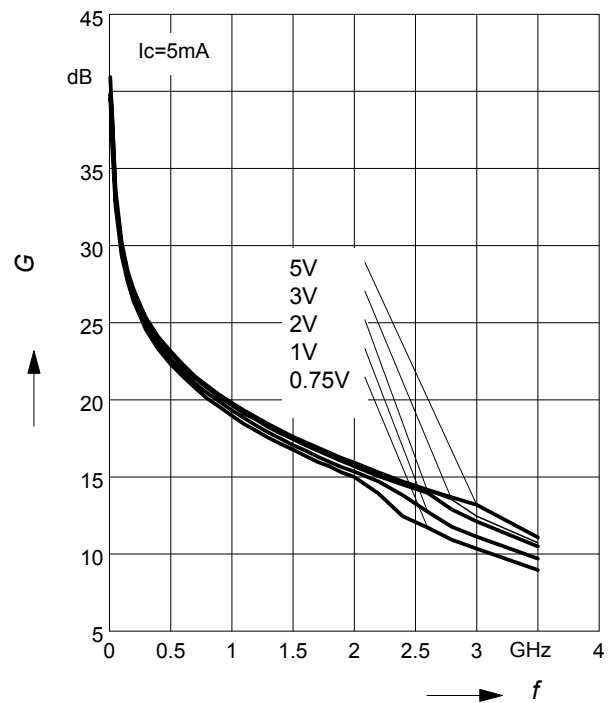
$f = 1.8\text{GHz}$

$V_{CE} = \text{parameter}$



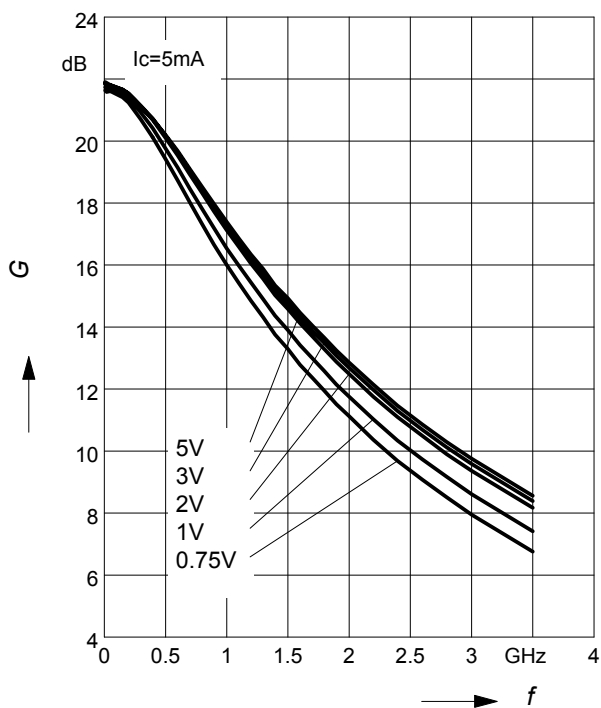
Power Gain G_{ma} , $G_{ms} = f(f)$

$V_{CE} = \text{parameter}$



Insertion Power Gain $|S_{21}|^2 = f(f)$

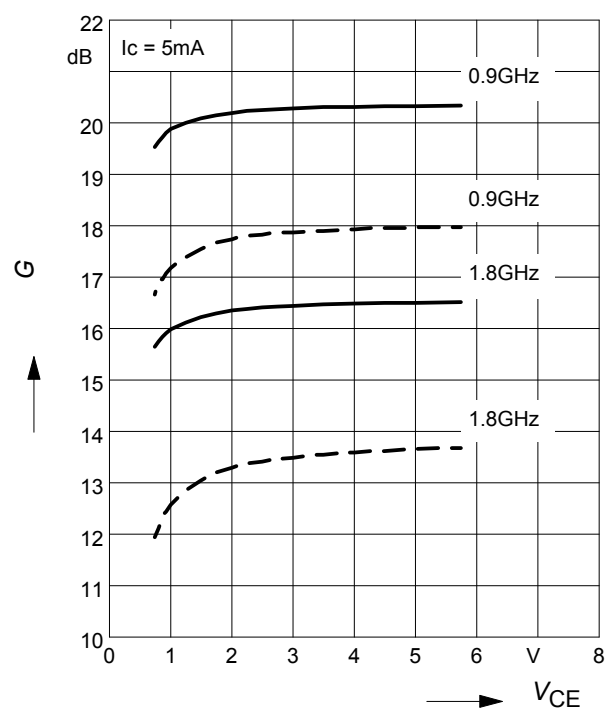
$V_{CE} = \text{parameter}$



Power Gain G_{ma} , $G_{ms} = f(V_{CE})$: —

$|S_{21}|^2 = f(V_{CE})$: - - -

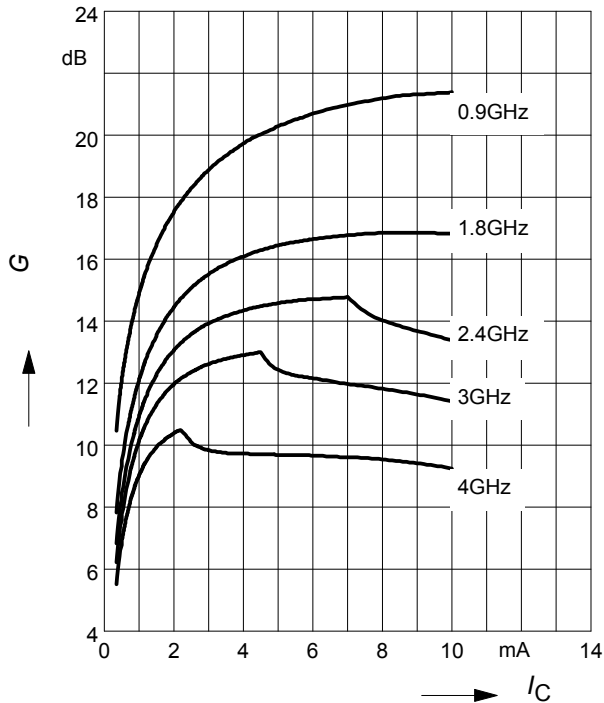
$f = \text{parameter}$



Power gain G_{ma} , $G_{ms} = f(I_C)$

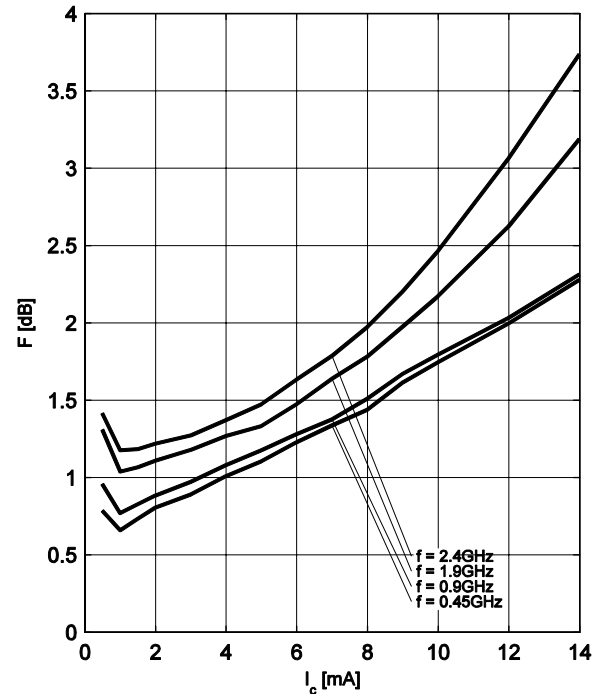
$V_{CE} = 3V$

$f = \text{parameter}$



Noise figure $F = f(I_C)$

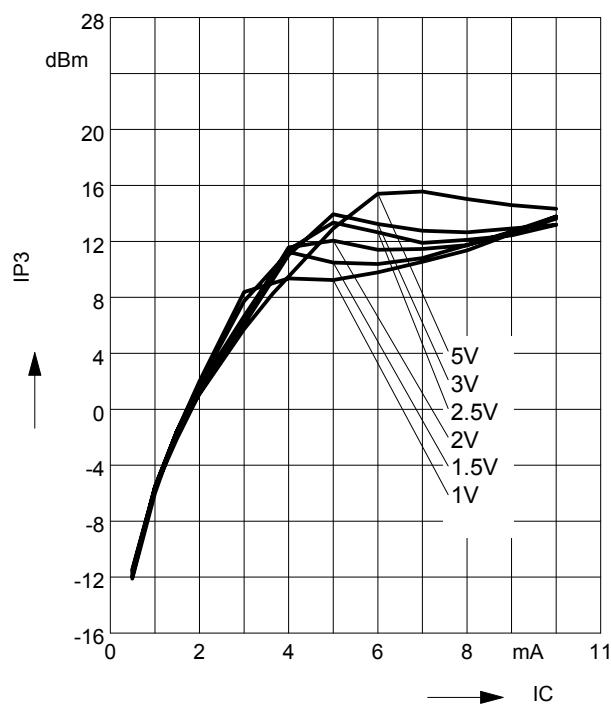
$V_{CE} = 1.5V$, $Z_S = Z_{Sopt}$



Third order Intercept Point $IP_3 = f(I_C)$

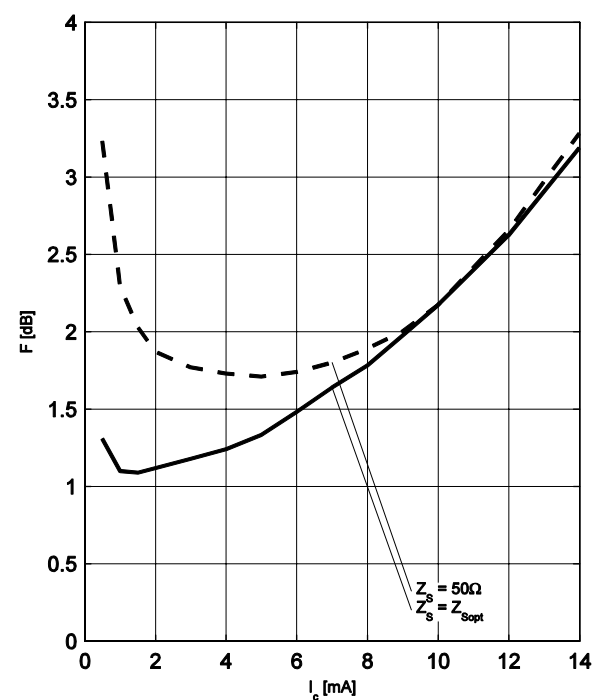
(Output, $Z_S = Z_L = 50\Omega$)

$V_{CE} = \text{parameter}$, $f = 100\text{MHz}$



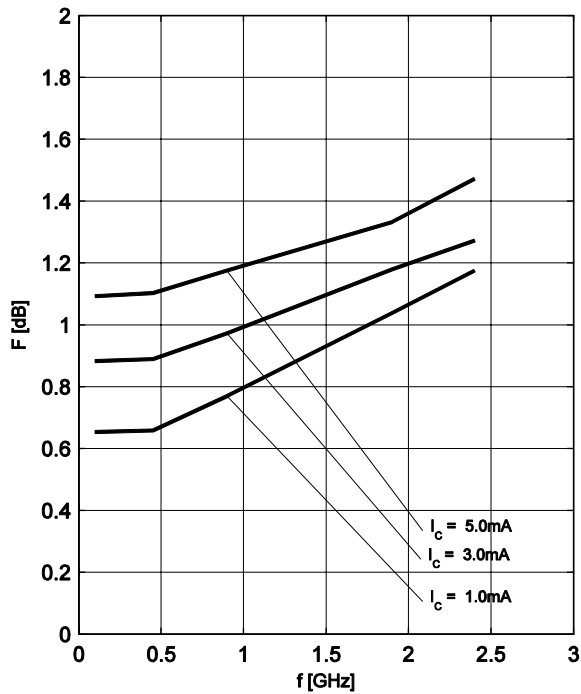
Noise figure $F = f(I_C)$

$V_{CE} = 1.5V$, $f = 1.9\text{GHz}$



Noise figure $F = f(f)$

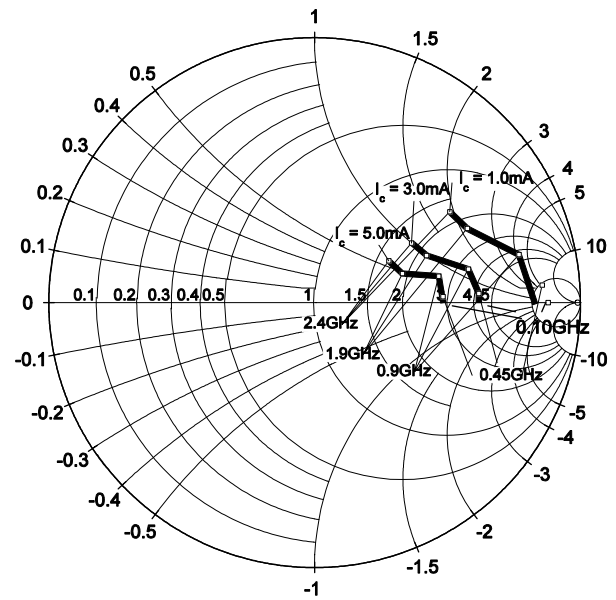
$V_{CE} = 1.5V$, $Z_S = Z_{Sopt}$, $I_C = \text{Parameter}$



Source impedance for min.

noise figure vs. frequency

$V_{CE} = 1.5V$, $I_C = \text{Parameter}$



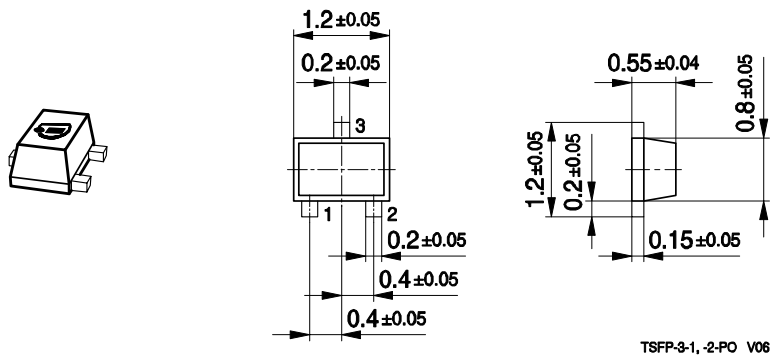
SPICE GP Model

For the SPICE Gummel Poon (GP) model as well as for the S-parameters (including noise parameters) please refer to our internet website

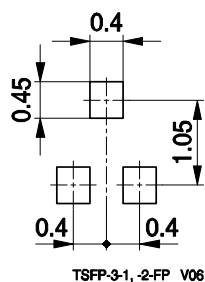
www.infineon.com/rf.models.

Please consult our website and download the latest versions before actually starting your design. You find the BFR340F SPICE GP model in the internet in MWO- and ADS-format, which you can import into these circuit simulation tools very quickly and conveniently. The model already contains the package parasitics and is ready to use for DC and high frequency simulations. The terminals of the model circuit correspond to the pin configuration of the device. The model parameters have been extracted and verified up to 10 GHz using typical devices. The BFR340F SPICE GP model reflects the typical DC- and RF-performance within the limitations which are given by the SPICE GP model itself. Besides the DC characteristics all S-parameters in magnitude and phase, as well as noise figure (including optimum source impedance, equivalent noise resistance and flicker noise) and intermodulation have been extracted.

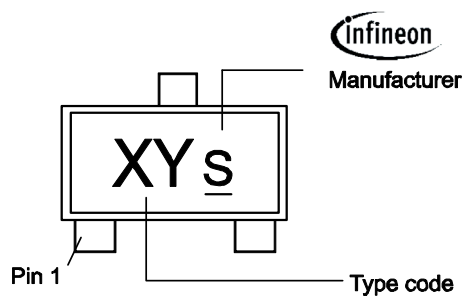
Package Outline



Foot Print



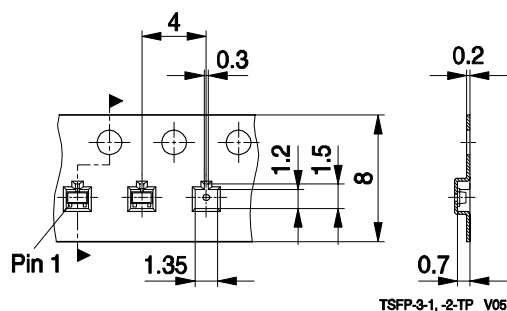
Marking Layout (Example)



Standard Packing

Reel Ø 180 mm = 3.000 Pieces/Reel

Reel Ø 330 mm = 10.000 Pieces/Reel



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